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### What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

### Applications of "[Embedded - Microcontrollers](#)"

#### Details

|                            |   |
|----------------------------|---|
| Product Status             | Active  |
| Core Processor             | PIC   |
| Core Size                  | 8-Bit   |
| Speed                      | 20MHz   |
| Connectivity               | -   |
| Peripherals                | POR, WDT  |
| Number of I/O              | 20  |
| Program Memory Size        | 3KB (2K x 12)   |
| Program Memory Type        | OTP   |
| EEPROM Size                | -   |
| RAM Size                   | 72 x 8  |
| Voltage - Supply (Vcc/Vdd) | 3V ~ 5.5V   |
| Data Converters            | -   |
| Oscillator Type            | External  |
| Operating Temperature      | 0°C ~ 70°C (TA)   |
| Mounting Type              | Through Hole  |
| Package / Case             | 28-DIP (0.300", 7.62mm)   |
| Supplier Device Package    | 28-SPDIP  |
| Purchase URL               | <a href="https://www.e-xfl.com/product-detail/microchip-technology/pic16c57c-20-sp">https://www.e-xfl.com/product-detail/microchip-technology/pic16c57c-20-sp</a> |

## 5.2 Device Reset Timer (DRT)

The Device Reset Timer (DRT) provides an 18 ms nominal time-out on RESET regardless of Oscillator mode used. The DRT operates on an internal RC oscillator. The processor is kept in RESET as long as the DRT is active. The DRT delay allows VDD to rise above VDD min., and for the oscillator to stabilize.

Oscillator circuits based on crystals or ceramic resonators require a certain time after power-up to establish a stable oscillation. The on-chip DRT keeps the device in a RESET condition for approximately 18 ms after the voltage on the MCLR/VPP pin has reached a logic high (VIH) level. Thus, external RC networks connected to the MCLR input are not required in most cases, allowing for savings in cost-sensitive and/or space restricted applications.

The Device Reset time delay will vary from chip to chip due to VDD, temperature, and process variation. See AC parameters for details.

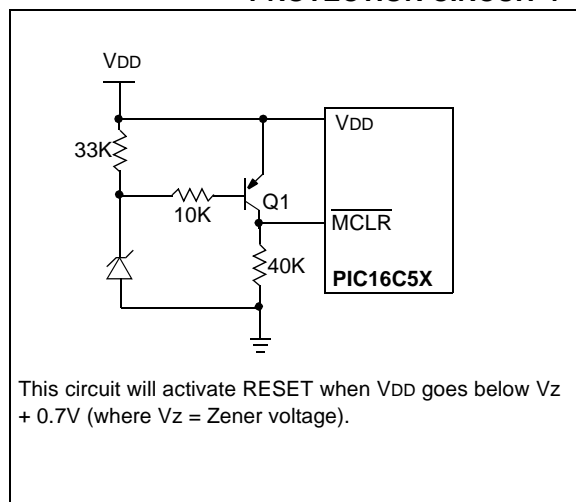
The DRT will also be triggered upon a Watchdog Timer time-out. This is particularly important for applications using the WDT to wake the PIC16C5X from SLEEP mode automatically.

## 5.3 Reset on Brown-Out

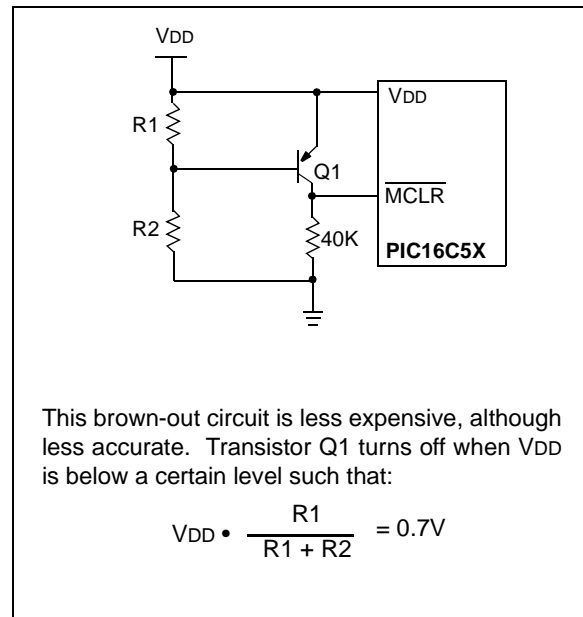
A brown-out is a condition where device power (VDD) dips below its minimum value, but not to zero, and then recovers. The device should be RESET in the event of a brown-out.

To RESET PIC16C5X devices when a brown-out occurs, external brown-out protection circuits may be built, as shown in Figure 5-6, Figure 5-7 and Figure 5-8.

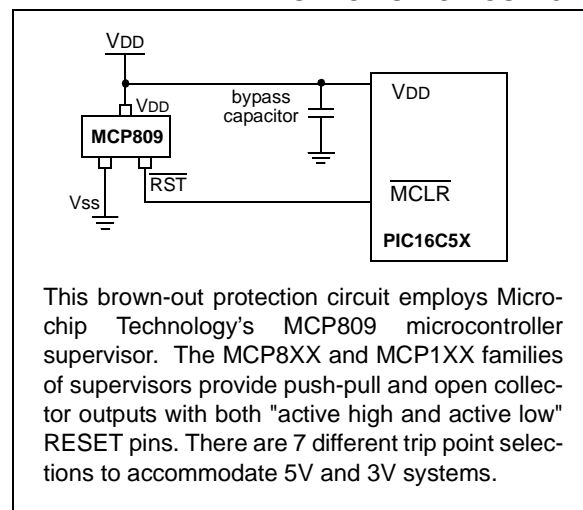
**FIGURE 5-6: EXTERNAL BROWN-OUT PROTECTION CIRCUIT 1**



**FIGURE 5-7: EXTERNAL BROWN-OUT PROTECTION CIRCUIT 2**



**FIGURE 5-8: EXTERNAL BROWN-OUT PROTECTION CIRCUIT 3**



## 6.0 MEMORY ORGANIZATION

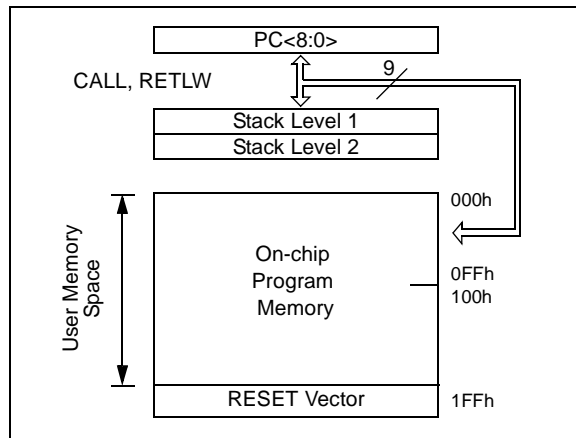
PIC16C5X memory is organized into program memory and data memory. For devices with more than 512 bytes of program memory, a paging scheme is used. Program memory pages are accessed using one or two STATUS Register bits. For devices with a data memory register file of more than 32 registers, a banking scheme is used. Data memory banks are accessed using the File Selection Register (FSR).

### 6.1 Program Memory Organization

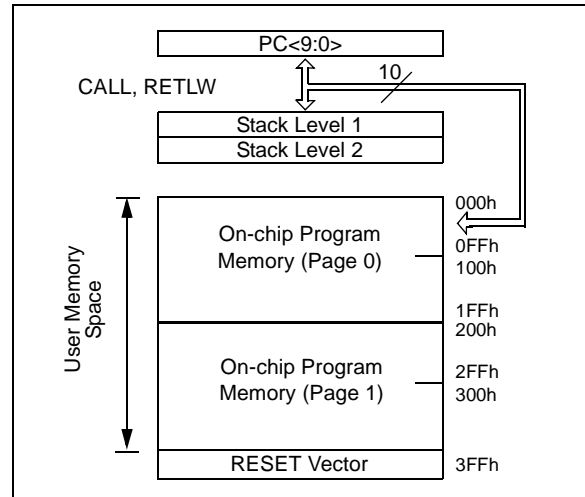
The PIC16C54, PIC16CR54 and PIC16C55 have a 9-bit Program Counter (PC) capable of addressing a 512 x 12 program memory space (Figure 6-1). The PIC16C56 and PIC16CR56 have a 10-bit Program Counter (PC) capable of addressing a 1K x 12 program memory space (Figure 6-2). The PIC16C57, PIC16C58 and PIC16CR58 have an 11-bit Program Counter (PC) capable of addressing a 2K x 12 program memory space (Figure 6-3). Accessing a location above the physically implemented address will cause a wraparound.

A NOP at the RESET vector location will cause a restart at location 000h. The RESET vector for the PIC16C54, PIC16CR54 and PIC16C55 is at 1FFh. The RESET vector for the PIC16C56 and PIC16CR56 is at 3FFh. The RESET vector for the PIC16C57, PIC16CR57, PIC16C58, and PIC16CR58 is at 7FFh. See Section 6.5 for additional information using CALL and GOTO instructions.

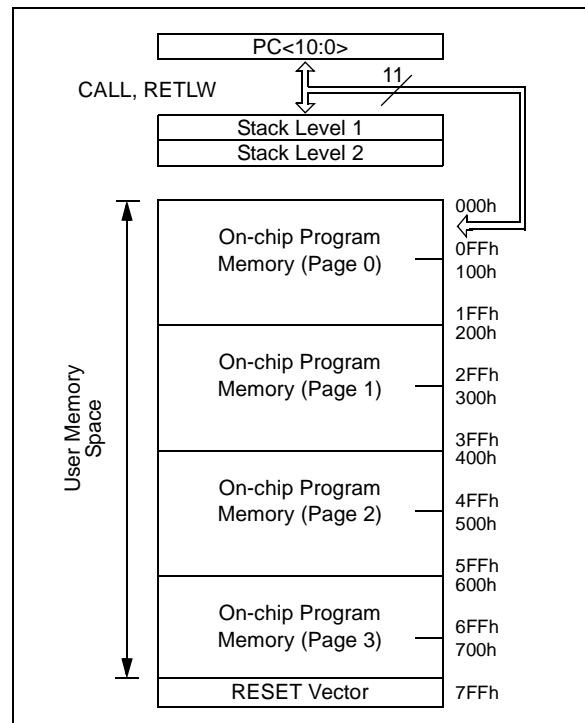
**FIGURE 6-1: PIC16C54/CR54/C55 PROGRAM MEMORY MAP AND STACK**



**FIGURE 6-2: PIC16C56/CR56 PROGRAM MEMORY MAP AND STACK**



**FIGURE 6-3: PIC16C57/CR57/C58/CR58 PROGRAM MEMORY MAP AND STACK**



# PIC16C5X

## COMF Complement f

Syntax: [ *label* ] COMF f,d

Operands:  $0 \leq f \leq 31$   
 $d \in [0,1]$

Operation:  $(f) \rightarrow (dest)$

Status Affected: Z

Encoding: 

|      |      |      |
|------|------|------|
| 0010 | 01df | ffff |
|------|------|------|

Description: The contents of register 'f' are complemented. If 'd' is 0 the result is stored in the W register. If 'd' is 1 the result is stored back in register 'f'.

Words: 1

Cycles: 1

Example: COMF REG1, 0

Before Instruction

REG1 = 0x13

After Instruction

REG1 = 0x13

W = 0xEC

## DECFSZ Decrement f

Syntax: [ *label* ] DECFSZ f,d

Operands:  $0 \leq f \leq 31$   
 $d \in [0,1]$

Operation:  $(f) - 1 \rightarrow (dest)$

Status Affected: Z

Encoding: 

|      |      |      |
|------|------|------|
| 0000 | 11df | ffff |
|------|------|------|

Description: Decrement register 'f'. If 'd' is 0 the result is stored in the W register. If 'd' is 1 the result is stored back in register 'f'.

Words: 1

Cycles: 1

Example: DECFSZ CNT, 1

Before Instruction

CNT = 0x01

Z = 0

After Instruction

CNT = 0x00

Z = 1

## DECFSZ Decrement f, Skip if 0

Syntax: [ *label* ] DECFSZ f,d

Operands:  $0 \leq f \leq 31$   
 $d \in [0,1]$

Operation:  $(f) - 1 \rightarrow d$ ; skip if result = 0

Status Affected: None

Encoding: 

|      |      |      |
|------|------|------|
| 0010 | 11df | ffff |
|------|------|------|

Description: The contents of register 'f' are decremented. If 'd' is 0 the result is placed in the W register. If 'd' is 1 the result is placed back in register 'f'.  
 If the result is 0, the next instruction, which is already fetched, is discarded and a NOP is executed instead making it a two-cycle instruction.

Words: 1

Cycles: 1(2)

Example: 

|          |        |        |
|----------|--------|--------|
| HERE     | DECFSZ | CNT, 1 |
|          | GOTO   | LOOP   |
| CONTINUE | •      |        |
|          | •      |        |
|          | •      |        |

Before Instruction

PC = address (HERE)

After Instruction

CNT = CNT - 1;

if CNT = 0,

PC = address (CONTINUE);

if CNT  $\neq$  0,

PC = address (HERE+1)

## 11.4 MPLINK Object Linker/ MPLIB Object Librarian

The MPLINK object linker combines relocatable objects created by the MPASM assembler and the MPLAB C17 and MPLAB C18 C compilers. It can also link relocatable objects from pre-compiled libraries, using directives from a linker script.

The MPLIB object librarian is a librarian for pre-compiled code to be used with the MPLINK object linker. When a routine from a library is called from another source file, only the modules that contain that routine will be linked in with the application. This allows large libraries to be used efficiently in many different applications. The MPLIB object librarian manages the creation and modification of library files.

The MPLINK object linker features include:

- Integration with MPASM assembler and MPLAB C17 and MPLAB C18 C compilers.
- Allows all memory areas to be defined as sections to provide link-time flexibility.

The MPLIB object librarian features include:

- Easier linking because single libraries can be included instead of many smaller files.
- Helps keep code maintainable by grouping related modules together.
- Allows libraries to be created and modules to be added, listed, replaced, deleted or extracted.

## 11.5 MPLAB SIM Software Simulator

The MPLAB SIM software simulator allows code development in a PC-hosted environment by simulating the PIC series microcontrollers on an instruction level. On any given instruction, the data areas can be examined or modified and stimuli can be applied from a file, or user-defined key press, to any of the pins. The execution can be performed in single step, execute until break, or trace mode.

The MPLAB SIM simulator fully supports symbolic debugging using the MPLAB C17 and the MPLAB C18 C compilers and the MPASM assembler. The software simulator offers the flexibility to develop and debug code outside of the laboratory environment, making it an excellent multi-project software development tool.

## 11.6 MPLAB ICE High Performance Universal In-Circuit Emulator with MPLAB IDE

The MPLAB ICE universal in-circuit emulator is intended to provide the product development engineer with a complete microcontroller design tool set for PIC microcontrollers (MCUs). Software control of the MPLAB ICE in-circuit emulator is provided by the MPLAB Integrated Development Environment (IDE), which allows editing, building, downloading and source debugging from a single environment.

The MPLAB ICE 2000 is a full-featured emulator system with enhanced trace, trigger and data monitoring features. Interchangeable processor modules allow the system to be easily reconfigured for emulation of different processors. The universal architecture of the MPLAB ICE in-circuit emulator allows expansion to support new PIC microcontrollers.

The MPLAB ICE in-circuit emulator system has been designed as a real-time emulation system, with advanced features that are generally found on more expensive development tools. The PC platform and Microsoft® Windows environment were chosen to best make these features available to you, the end user.

## 11.7 ICEPIC In-Circuit Emulator

The ICEPIC low cost, in-circuit emulator is a solution for the Microchip Technology PIC16C5X, PIC16C6X, PIC16C7X and PIC16CXXX families of 8-bit One-Time-Programmable (OTP) microcontrollers. The modular system can support different subsets of PIC16C5X or PIC16CXXX products through the use of interchangeable personality modules, or daughter boards. The emulator is capable of emulating without target application circuitry being present.

# PIC16C5X

## 12.3 DC Characteristics: PIC16C54/55/56/57-RCE, XTE, 10E, HSE, LPE (Extended)

| PIC16C54/55/56/57-RCE, XTE, 10E, HSE, LPE (Extended) |        |   | Standard Operating Conditions (unless otherwise specified)<br>Operating Temperature $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$ for extended |      |     |       |   |
|--|--------|---|---|------|-----|-------|---|
| Param No.  | Symbol | Characteristic/Device                             | Min   | Typ† | Max | Units | Conditions                                    |
| D001   | VDD    | <b>Supply Voltage</b>                             |   |      |     |       |   |
|  |        | PIC16C5X-RCE                                      | 3.25  | —    | 6.0 | V     |   |
|  |        | PIC16C5X-XTE                                      | 3.25  | —    | 6.0 | V     |   |
|  |        | PIC16C5X-10E                                      | 4.5   | —    | 5.5 | V     |   |
|  |        | PIC16C5X-HSE                                      | 4.5   | —    | 5.5 | V     |   |
|  |        | PIC16C5X-LPE                                      | 2.5   | —    | 6.0 | V     |   |
| D002   | VDR    | <b>RAM Data Retention Voltage</b> <sup>(1)</sup>  | —   | 1.5* | —   | V     | Device in SLEEP mode                          |
| D003   | VPOR   | <b>VDD Start Voltage</b> to ensure Power-on Reset | —   | VSS  | —   | V     | See Section 5.1 for details on Power-on Reset |
| D004   | SVDD   | <b>VDD Rise Rate</b> to ensure Power-on Reset     | 0.05*   | —    | —   | V/ms  | See Section 5.1 for details on Power-on Reset |
| D010   | IDD    | <b>Supply Current</b> <sup>(2)</sup>              |   |      |     |       |   |
|  |        | PIC16C5X-RCE <sup>(3)</sup>                       | —   | 1.8  | 3.3 | mA    | FOSC = 4 MHz, VDD = 5.5V                      |
|  |        | PIC16C5X-XTE                                      | —   | 1.8  | 3.3 | mA    | FOSC = 4 MHz, VDD = 5.5V                      |
|  |        | PIC16C5X-10E                                      | —   | 4.8  | 10  | mA    | FOSC = 10 MHz, VDD = 5.5V                     |
|  |        | PIC16C5X-HSE                                      | —   | 4.8  | 10  | mA    | FOSC = 10 MHz, VDD = 5.5V                     |
|  |        | PIC16C5X-HSE                                      | —   | 9.0  | 20  | mA    | FOSC = 16 MHz, VDD = 5.5V                     |
| D020   | IPD    | <b>Power-down Current</b> <sup>(2)</sup>          | —   | 5.0  | 22  | μA    | VDD = 3.25V, WDT enabled                      |
|  |        |   | —   | 0.8  | 18  | μA    | VDD = 3.25V, WDT disabled                     |

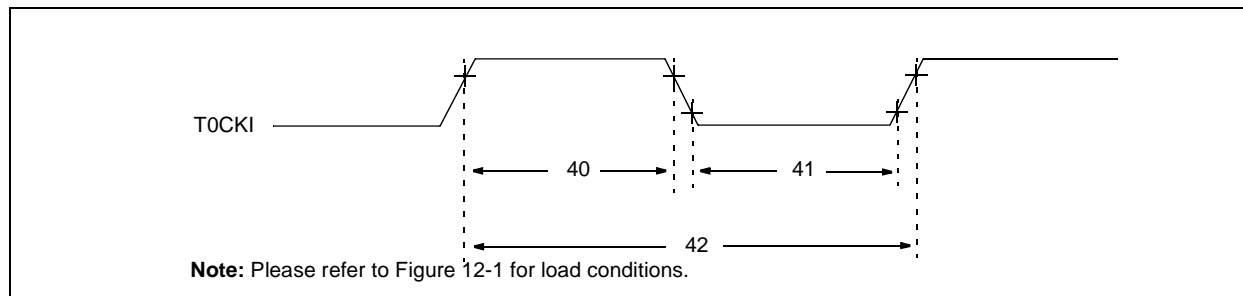
\* These parameters are characterized but not tested.

† Data in "Typ" column is based on characterization results at 25°C. This data is for design guidance only and is not tested.

- Note 1:** This is the limit to which VDD can be lowered in SLEEP mode without losing RAM data.
- 2:** The supply current is mainly a function of the operating voltage and frequency. Other factors such as bus loading, oscillator type, bus rate, internal code execution pattern and temperature also have an impact on the current consumption.
- The test conditions for all IDD measurements in active Operation mode are: OSC1 = external square wave, from rail-to-rail; all I/O pins tristated, pulled to VSS, T0CKI = VDD, MCLR = VDD; WDT enabled/disabled as specified.
  - For standby current measurements, the conditions are the same, except that the device is in SLEEP mode. The power-down current in SLEEP mode does not depend on the oscillator type.
- 3:** Does not include current through REXT. The current through the resistor can be estimated by the formula:  $I_R = VDD/2R_{EXT}$  (mA) with REXT in kΩ.

# PIC16C5X

**FIGURE 12-5: TIMER0 CLOCK TIMINGS - PIC16C54/55/56/57**



**TABLE 12-4: TIMER0 CLOCK REQUIREMENTS - PIC16C54/55/56/57**

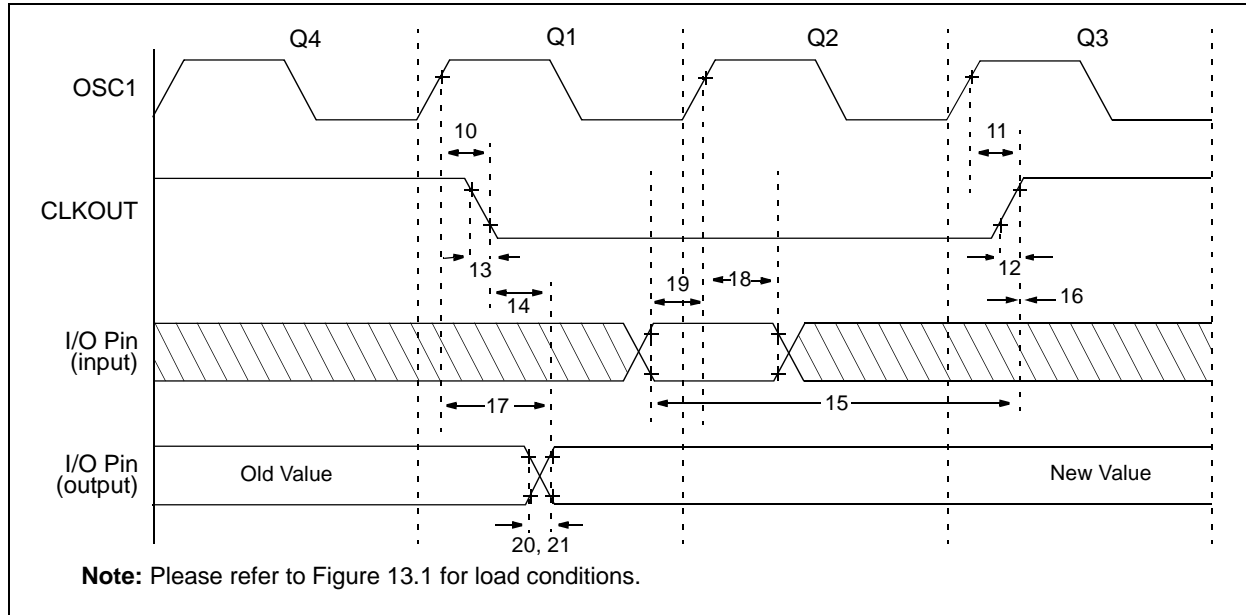
| AC Characteristics |        | Standard Operating Conditions (unless otherwise specified) |                              |      |     |       |   |
|--------------------|--------|--|------------------------------|------|-----|-------|---|
|                    |        | Operating Temperature                                      |                              |      |     |       |   |
|                    |        | 0°C ≤ TA ≤ +70°C for commercial                            |                              |      |     |       |   |
|                    |        | −40°C ≤ TA ≤ +85°C for industrial                          |                              |      |     |       |   |
|                    |        | −40°C ≤ TA ≤ +125°C for extended                           |                              |      |     |       |   |
| Param No.          | Symbol | Characteristic   | Min                          | Typ† | Max | Units | Conditions  |
| 40                 | Tt0H   | T0CKI High Pulse Width                                     |                              |      |     |       |   |
|                    |        | - No Prescaler   | 0.5 Tcy + 20*                | —    | —   | ns    |   |
|                    |        | - With Prescaler   | 10*                          | —    | —   | ns    |   |
| 41                 | Tt0L   | T0CKI Low Pulse Width                                      |                              |      |     |       |   |
|                    |        | - No Prescaler   | 0.5 Tcy + 20*                | —    | —   | ns    |   |
|                    |        | - With Prescaler   | 10*                          | —    | —   | ns    |   |
| 42                 | Tt0P   | T0CKI Period   | 20 or $\frac{Tcy + 40}{N}$ * | —    | —   | ns    | Whichever is greater.<br>N = Prescale Value<br>(1, 2, 4,..., 256) |

\* These parameters are characterized but not tested.

† Data in the Typical ("Typ") column is at 5.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

# PIC16C5X

**FIGURE 13-3: CLKOUT AND I/O TIMING - PIC16CR54A**



**TABLE 13-2: CLKOUT AND I/O TIMING REQUIREMENTS - PIC16CR54A**

| AC Characteristics |          | Standard Operating Conditions (unless otherwise specified) |              |      |      |       |
|--------------------|----------|--|--------------|------|------|-------|
|                    |          | Operating Temperature                                      |              |      |      |       |
|                    |          | 0°C ≤ TA ≤ +70°C for commercial                            |              |      |      |       |
|                    |          | -40°C ≤ TA ≤ +85°C for industrial                          |              |      |      |       |
|                    |          | -40°C ≤ TA ≤ +125°C for extended                           |              |      |      |       |
| Param No.          | Symbol   | Characteristic   | Min          | Typ† | Max  | Units |
| 10                 | TosH2ckL | OSC1↑ to CLKOUT↓ <sup>(1)</sup>                            | —            | 15   | 30** | ns    |
| 11                 | TosH2ckH | OSC1↑ to CLKOUT↑ <sup>(1)</sup>                            | —            | 15   | 30** | ns    |
| 12                 | TckR     | CLKOUT rise time <sup>(1)</sup>                            | —            | 5.0  | 15** | ns    |
| 13                 | TckF     | CLKOUT fall time <sup>(1)</sup>                            | —            | 5.0  | 15** | ns    |
| 14                 | TckL2ioV | CLKOUT↓ to Port out valid <sup>(1)</sup>                   | —            | —    | 40** | ns    |
| 15                 | TioV2ckH | Port in valid before CLKOUT↑ <sup>(1)</sup>                | 0.25 TCY+30* | —    | —    | ns    |
| 16                 | TckH2ioI | Port in hold after CLKOUT↑ <sup>(1)</sup>                  | 0*           | —    | —    | ns    |
| 17                 | TosH2ioV | OSC1↑ (Q1 cycle) to Port out valid <sup>(2)</sup>          | —            | —    | 100* | ns    |
| 18                 | TosH2ioI | OSC1↑ (Q2 cycle) to Port input invalid (I/O in hold time)  | TBD          | —    | —    | ns    |
| 19                 | TioV2osH | Port input valid to OSC1↑ (I/O in setup time)              | TBD          | —    | —    | ns    |
| 20                 | TioR     | Port output rise time <sup>(2)</sup>                       | —            | 10   | 25** | ns    |
| 21                 | TioF     | Port output fall time <sup>(2)</sup>                       | —            | 10   | 25** | ns    |

\* These parameters are characterized but not tested.

\*\* These parameters are design targets and are not tested. No characterization data available at this time.

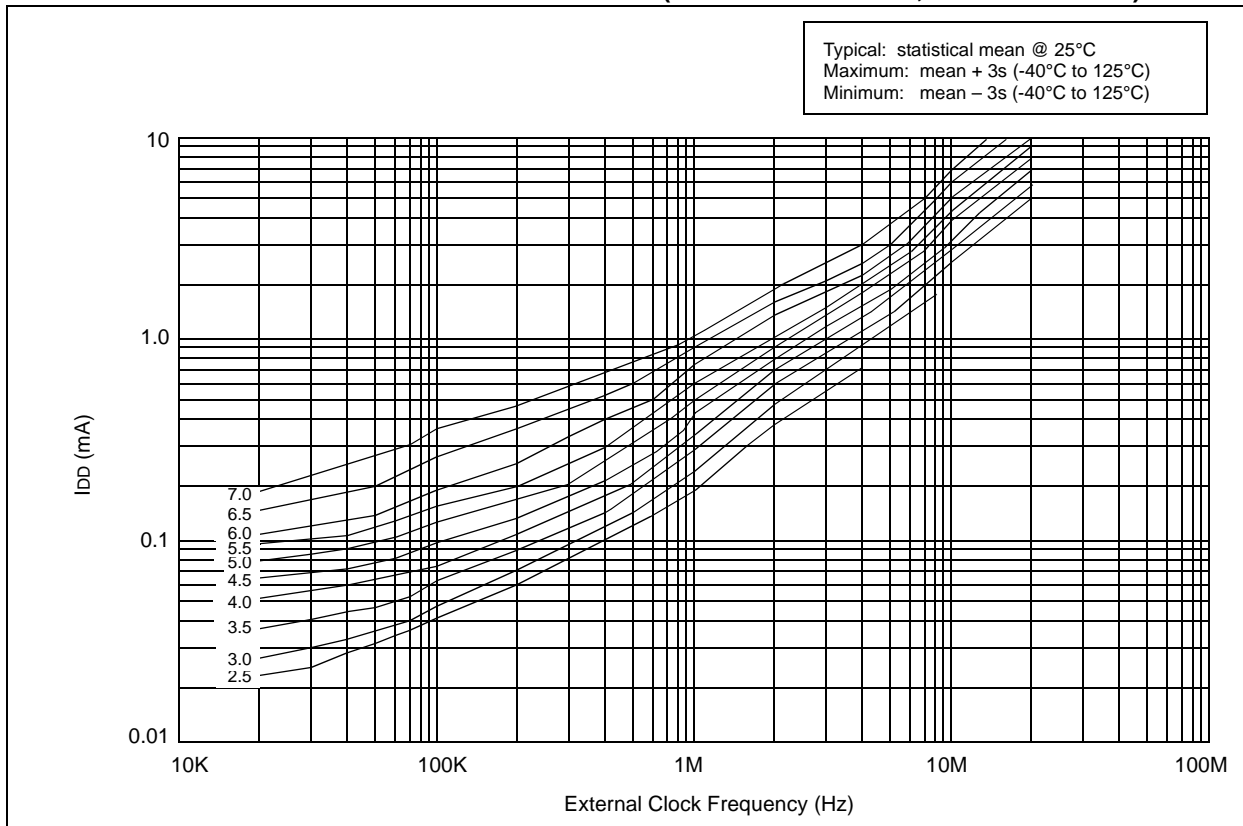
† Data in the Typical ("Typ") column is based on characterization results at 25°C. This data is for design guidance only and is not tested.

**Note 1:** Measurements are taken in RC Mode where CLKOUT output is 4 x TOSC.

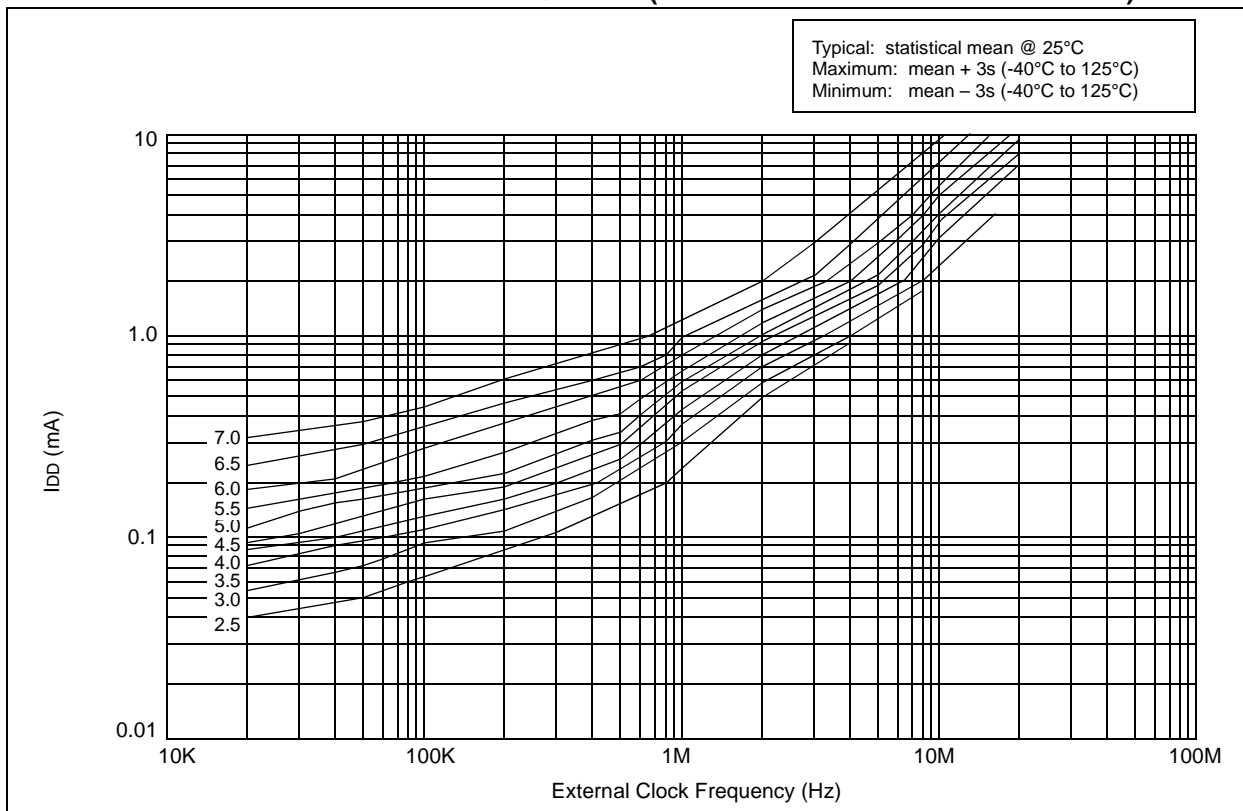
**Note 2:** Please refer to Figure 13.1 for load conditions.



**FIGURE 14-13: MAXIMUM IDD VS. FREQUENCY (EXTERNAL CLOCK, -40°C TO +85°C)**



**FIGURE 14-14: MAXIMUM  $I_{DD}$  vs. FREQUENCY (EXTERNAL CLOCK -55°C TO +125°C)**



# PIC16C5X

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**TABLE 14-2: INPUT CAPACITANCE FOR  
PIC16C54/56**

| Pin                      | Typical Capacitance (pF) |          |
|--------------------------|--------------------------|----------|
|                          | 18L PDIP                 | 18L SOIC |
| RA port                  | 5.0                      | 4.3      |
| RB port                  | 5.0                      | 4.3      |
| $\overline{\text{MCLR}}$ | 17.0                     | 17.0     |
| OSC1                     | 4.0                      | 3.5      |
| OSC2/CLKOUT              | 4.3                      | 3.5      |
| T0CKI                    | 3.2                      | 2.8      |

All capacitance values are typical at 25°C. A part-to-part variation of  $\pm 25\%$  (three standard deviations) should be taken into account.

**TABLE 14-3: INPUT CAPACITANCE FOR  
PIC16C55/57**

| Pin                      | Typical Capacitance (pF) |          |
|--------------------------|--------------------------|----------|
|                          | 28L PDIP<br>(600 mil)    | 28L SOIC |
| RA port                  | 5.2                      | 4.8      |
| RB port                  | 5.6                      | 4.7      |
| RC port                  | 5.0                      | 4.1      |
| $\overline{\text{MCLR}}$ | 17.0                     | 17.0     |
| OSC1                     | 6.6                      | 3.5      |
| OSC2/CLKOUT              | 4.6                      | 3.5      |
| T0CKI                    | 4.5                      | 3.5      |

All capacitance values are typical at 25°C. A part-to-part variation of  $\pm 25\%$  (three standard deviations) should be taken into account.

# PIC16C5X

## 15.2 DC Characteristics: PIC16C54A-04E, 10E, 20E (Extended) PIC16LC54A-04E (Extended)

| PIC16LC54A-04E<br>(Extended)          |        | Standard Operating Conditions (unless otherwise specified)<br>Operating Temperature $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$ for extended |            |        |              |        |  |
|---------------------------------------|--------|---|------------|--------|--------------|--------|--|
| PIC16C54A-04E, 10E, 20E<br>(Extended) |        | Standard Operating Conditions (unless otherwise specified)<br>Operating Temperature $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$ for extended |            |        |              |        |  |
| Param No.                             | Symbol | Characteristic  | Min        | Typ†   | Max          | Units  | Conditions   |
| D001                                  | VDD    | <b>Supply Voltage</b>   |            |        |              |        |  |
|                                       |        | PIC16LC54A  | 3.0<br>2.5 | —<br>— | 6.25<br>6.25 | V<br>V | XT and RC modes<br>LP mode                                 |
| D001A                                 |        | PIC16C54A   | 3.5<br>4.5 | —<br>— | 5.5<br>5.5   | V<br>V | RC and XT modes<br>HS mode                                 |
| D002                                  | VDR    | <b>RAM Data Retention Voltage</b> <sup>(1)</sup>  | —          | 1.5*   | —            | V      | Device in SLEEP mode                                       |
| D003                                  | VPOR   | <b>VDD Start Voltage</b> to ensure Power-on Reset   | —          | VSS    | —            | V      | See Section 5.1 for details on Power-on Reset              |
| D004                                  | SVDD   | <b>VDD Rise Rate</b> to ensure Power-on Reset   | 0.05*      | —      | —            | V/ms   | See Section 5.1 for details on Power-on Reset              |
| D010                                  | IDD    | <b>Supply Current</b> <sup>(2)</sup>  |            |        |              |        |  |
|                                       |        | PIC16LC54A  | —          | 0.5    | 25           | mA     | FOSC = 4.0 MHz, VDD = 5.5V, RC <sup>(3)</sup> and XT modes |
|                                       |        |   | —          | 11     | 27           | μA     | FOSC = 32 kHz, VDD = 2.5V, LP mode, Commercial             |
|                                       |        |   | —          | 11     | 35           | μA     | FOSC = 32 kHz, VDD = 2.5V, LP mode, Industrial             |
|                                       |        |   | —          | 11     | 37           | μA     | FOSC = 32 kHz, VDD = 2.5V, LP mode, Extended               |
| D010A                                 |        | PIC16C54A   | —          | 1.8    | 3.3          | mA     | FOSC = 4.0 MHz, VDD = 5.5V, RC <sup>(3)</sup> and XT modes |
|                                       |        |   | —          | 4.8    | 10           | mA     | FOSC = 10 MHz, VDD = 5.5V, HS mode                         |
|                                       |        |   | —          | 9.0    | 20           | mA     | FOSC = 20 MHz, VDD = 5.5V, HS mode                         |

Legend: Rows with standard voltage device data only are shaded for improved readability.

\* These parameters are characterized but not tested.

† Data in the Typical ("Typ") column is based on characterization results at 25°C. This data is for design guidance only and is not tested.

**Note 1:** This is the limit to which VDD can be lowered in SLEEP mode without losing RAM data.

**Note 2:** The supply current is mainly a function of the operating voltage and frequency. Other factors such as bus loading, oscillator type, bus rate, internal code execution pattern and temperature also have an impact on the current consumption.

a) The test conditions for all IDD measurements in active Operation mode are: OSC1 = external square wave, from rail-to-rail; all I/O pins tristated, pulled to VSS, T0CKI = VDD, MCLR = VDD; WDT enabled/disabled as specified.

b) For standby current measurements, the conditions are the same, except that the device is in SLEEP mode. The power-down current in SLEEP mode does not depend on the oscillator type.

**Note 3:** Does not include current through REXT. The current through the resistor can be estimated by the formula:  $I_R = V_{DD}/2R_{EXT}$  (mA) with REXT in kΩ.

15.5 Timing Parameter Symbolology and Load Conditions

The timing parameter symbols have been created with one of the following formats:

- 1. TppS2ppS
- 2. TppS

|             |      |
|-------------|------|
| T           | T    |
| F Frequency | Time |

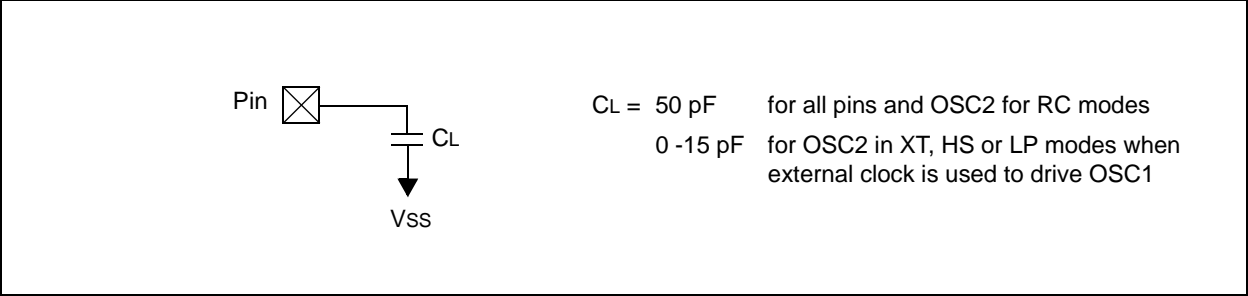
Lowercase letters (pp) and their meanings:

|                        |                    |
|------------------------|--------------------|
| pp                     |                    |
| 2 to                   | mc MCLR            |
| ck CLKOUT              | osc oscillator     |
| cy cycle time          | os OSC1            |
| drt device reset timer | t0 T0CKI           |
| io I/O port            | wdt watchdog timer |

Uppercase letters and their meanings:

|                          |                |
|--------------------------|----------------|
| S                        |                |
| F Fall                   | P Period       |
| H High                   | R Rise         |
| I Invalid (Hi-impedance) | V Valid        |
| L Low                    | Z Hi-impedance |

FIGURE 15-1: LOAD CONDITIONS FOR DEVICE TIMING SPECIFICATIONS - PIC16C54A



# PIC16C5X

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NOTES:

## 17.1 DC Characteristics: PIC16C54C/C55A/C56A/C57C/C58B-04, 20 (Commercial, Industrial) PIC16LC54C/LC55A/LC56A/LC57C/LC58B-04 (Commercial, Industrial) PIC16CR54C/CR56A/CR57C/CR58B-04, 20 (Commercial, Industrial) PIC16LCR54C/LCR56A/LCR57C/LCR58B-04 (Commercial, Industrial)

| <b>PIC16LC5X</b><br><b>PIC16LCR5X</b><br>(Commercial, Industrial) |        | <b>Standard Operating Conditions (unless otherwise specified)</b><br>Operating Temperature 0°C ≤ TA ≤ +70°C for commercial<br>-40°C ≤ TA ≤ +85°C for industrial |     |      |      |       |  |
|---|--------|---|-----|------|------|-------|--|
| <b>PIC16C5X</b><br><b>PIC16CR5X</b><br>(Commercial, Industrial)   |        | <b>Standard Operating Conditions (unless otherwise specified)</b><br>Operating Temperature 0°C ≤ TA ≤ +70°C for commercial<br>-40°C ≤ TA ≤ +85°C for industrial |     |      |      |       |  |
| Param No.   | Symbol | Characteristic/Device   | Min | Typ† | Max  | Units | Conditions                                     |
| D010  | IDD    | <b>Supply Current<sup>(2,3)</sup></b>   |     |      |      |       |  |
|   |        | PIC16LC5X   | —   | 0.5  | 2.4  | mA    | FOSC = 4.0 MHz, VDD = 5.5V, XT and RC modes    |
|   |        |   | —   | 11   | 27   | μA    | FOSC = 32 kHz, VDD = 2.5V, LP mode, Commercial |
| D010A   |        | PIC16C5X  | —   | 14   | 35   | μA    | FOSC = 32 kHz, VDD = 2.5V, LP mode, Industrial |
|   |        |   | —   | 1.8  | 2.4  | mA    | FOSC = 4 MHz, VDD = 5.5V, XT and RC modes      |
|   |        |   | —   | 2.6  | 3.6* | mA    | FOSC = 10 MHz, VDD = 3.0V, HS mode             |
|   |        |   | —   | 4.5  | 16   | mA    | FOSC = 20 MHz, VDD = 5.5V, HS mode             |
|   |        |   | —   | 14   | 32   | μA    | FOSC = 32 kHz, VDD = 3.0V, LP mode, Commercial |
|   |        |   | —   | 17   | 40   | μA    | FOSC = 32 kHz, VDD = 3.0V, LP mode, Industrial |

Legend: Rows with standard voltage device data only are shaded for improved readability.

\* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C, unless otherwise stated. These parameters are for design guidance only, and are not tested.

**Note 1:** This is the limit to which VDD can be lowered in SLEEP mode without losing RAM data.

**2:** The supply current is mainly a function of the operating voltage and frequency. Other factors such as bus loading, oscillator type, bus rate, internal code execution pattern and temperature also have an impact on the current consumption.

a) The test conditions for all IDD measurements in active Operation mode are: OSC1 = external square wave, from rail-to-rail; all I/O pins tristated, pulled to VSS, T0CKI = VDD, MCLR = VDD; WDT enabled/disabled as specified.

b) For standby current measurements, the conditions are the same, except that the device is in SLEEP mode. The power-down current in SLEEP mode does not depend on the oscillator type.

**3:** Does not include current through REXT. The current through the resistor can be estimated by the formula: IR = VDD/2REXT (mA) with REXT in kΩ.

# PIC16C5X

## 17.1 DC Characteristics: PIC16C54C/C55A/C56A/C57C/C58B-04, 20 (Commercial, Industrial) PIC16LC54C/LC55A/LC56A/LC57C/LC58B-04 (Commercial, Industrial) PIC16CR54C/CR56A/CR57C/CR58B-04, 20 (Commercial, Industrial) PIC16LCR54C/LCR56A/LCR57C/LCR58B-04 (Commercial, Industrial)

| <b>PIC16C5X</b><br><b>PIC16LCR5X</b><br>(Commercial, Industrial) |        | <b>Standard Operating Conditions (unless otherwise specified)</b><br>Operating Temperature $0^{\circ}\text{C} \leq T_A \leq +70^{\circ}\text{C}$ for commercial<br>$-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ for industrial |     |      |      |       |                                      |
|--|--------|---|-----|------|------|-------|--------------------------------------|
| <b>PIC16C5X</b><br><b>PIC16CR5X</b><br>(Commercial, Industrial)  |        | <b>Standard Operating Conditions (unless otherwise specified)</b><br>Operating Temperature $0^{\circ}\text{C} \leq T_A \leq +70^{\circ}\text{C}$ for commercial<br>$-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ for industrial |     |      |      |       |                                      |
| Param No.  | Symbol | Characteristic/Device   | Min | Typ† | Max  | Units | Conditions                           |
| D020   | IPD    | <b>Power-down Current<sup>(2)</sup></b>   |     |      |      |       |                                      |
|  |        | PIC16LC5X   | —   | 0.25 | 2    | μA    | VDD = 2.5V, WDT disabled, Commercial |
|  |        |   | —   | 0.25 | 3    | μA    | VDD = 2.5V, WDT disabled, Industrial |
|  |        |   | —   | 1    | 5    | μA    | VDD = 2.5V, WDT enabled, Commercial  |
|  |        |   | —   | 1.25 | 8    | μA    | VDD = 2.5V, WDT enabled, Industrial  |
| D020A  |        | PIC16C5X  | —   | 0.25 | 4.0  | μA    | VDD = 3.0V, WDT disabled, Commercial |
|  |        |   | —   | 0.25 | 5.0  | μA    | VDD = 3.0V, WDT disabled, Industrial |
|  |        |   | —   | 1.8  | 7.0* | μA    | VDD = 5.5V, WDT disabled, Commercial |
|  |        |   | —   | 2.0  | 8.0* | μA    | VDD = 5.5V, WDT disabled, Industrial |
|  |        |   | —   | 4    | 12*  | μA    | VDD = 3.0V, WDT enabled, Commercial  |
|  |        |   | —   | 4    | 14*  | μA    | VDD = 3.0V, WDT enabled, Industrial  |
|  |        |   | —   | 9.8  | 27*  | μA    | VDD = 5.5V, WDT enabled, Commercial  |
|  |        |   | —   | 12   | 30*  | μA    | VDD = 5.5V, WDT enabled, Industrial  |

Legend: Rows with standard voltage device data only are shaded for improved readability.

\* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C, unless otherwise stated. These parameters are for design guidance only, and are not tested.

- Note 1:** This is the limit to which VDD can be lowered in SLEEP mode without losing RAM data.
- Note 2:** The supply current is mainly a function of the operating voltage and frequency. Other factors such as bus loading, oscillator type, bus rate, internal code execution pattern and temperature also have an impact on the current consumption.
- a) The test conditions for all IDD measurements in active Operation mode are: OSC1 = external square wave, from rail-to-rail; all I/O pins tristated, pulled to VSS, T0CKI = VDD, MCLR = VDD; WDT enabled/disabled as specified.
- b) For standby current measurements, the conditions are the same, except that the device is in SLEEP mode. The power-down current in SLEEP mode does not depend on the oscillator type.
- Note 3:** Does not include current through REXT. The current through the resistor can be estimated by the formula:  
 $I_R = V_{DD}/2R_{EXT}$  (mA) with REXT in kΩ.

**TABLE 17-1: EXTERNAL CLOCK TIMING REQUIREMENTS - PIC16C5X, PIC16CR5X**

| <b>Standard Operating Conditions (unless otherwise specified)</b><br>Operating Temperature $0^{\circ}\text{C} \leq T_A \leq +70^{\circ}\text{C}$ for commercial<br>$-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ for industrial<br>$-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$ for extended |            |                                       |      |        |     |       |               |
|--|------------|---------------------------------------|------|--------|-----|-------|---------------|
| Param No.  | Symbol     | Characteristic                        | Min  | Typ†   | Max | Units | Conditions    |
| 2  | Tcy        | Instruction Cycle Time <sup>(2)</sup> | —    | 4/FOSC | —   | —     |               |
| 3  | TosL, TosH | Clock in (OSC1) Low or High Time      | 50*  | —      | —   | ns    | XT oscillator |
|  |            |                                       | 20*  | —      | —   | ns    | HS oscillator |
|  |            |                                       | 2.0* | —      | —   | μs    | LP oscillator |
| 4  | TosR, TosF | Clock in (OSC1) Rise or Fall Time     | —    | —      | 25* | ns    | XT oscillator |
|  |            |                                       | —    | —      | 25* | ns    | HS oscillator |
|  |            |                                       | —    | —      | 50* | ns    | LP oscillator |

\* These parameters are characterized but not tested.

† Data in the Typical ("Typ") column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

**Note 1:** All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption.

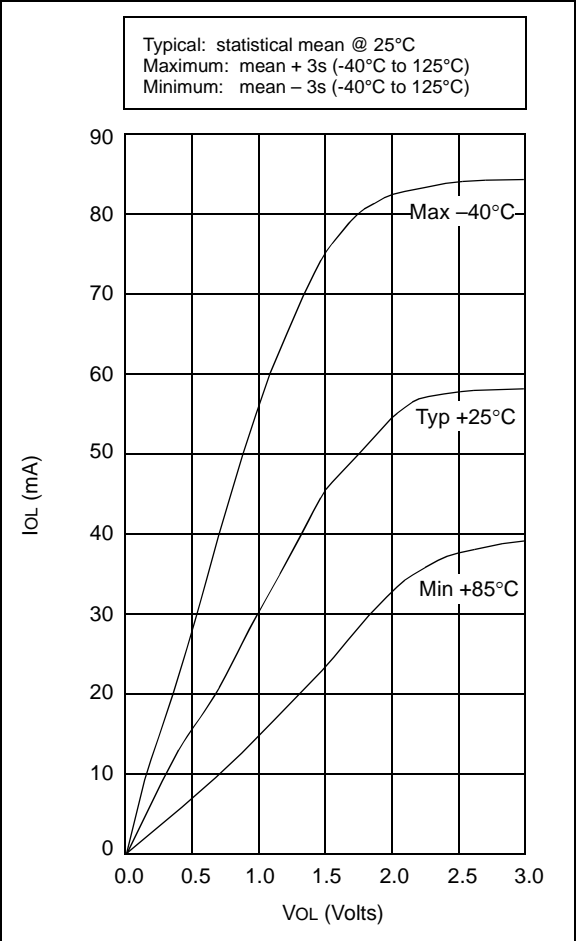
When an external clock input is used, the "max" cycle time limit is "DC" (no clock) for all devices.

**2:** Instruction cycle period (Tcy) equals four times the input oscillator time base period.



# PIC16C5X

**FIGURE 18-18:    PORTA, B AND C IoL vs.  
VOL, VDD = 5 V**



**TABLE 18-2:    INPUT CAPACITANCE**

| Pin         | Typical Capacitance (pF) |          |
|-------------|--------------------------|----------|
|             | 18L PDIP                 | 18L SOIC |
| RA port     | 5.0                      | 4.3      |
| RB port     | 5.0                      | 4.3      |
| MCLR        | 17.0                     | 17.0     |
| OSC1        | 4.0                      | 3.5      |
| OSC2/CLKOUT | 4.3                      | 3.5      |
| T0CKI       | 3.2                      | 2.8      |

All capacitance values are typical at 25°C. A part-to-part variation of ±25% (three standard deviations) should be taken into account.

FIGURE 20-2: TYPICAL IPD vs. VDD, WATCHDOG ENABLED (25°C)

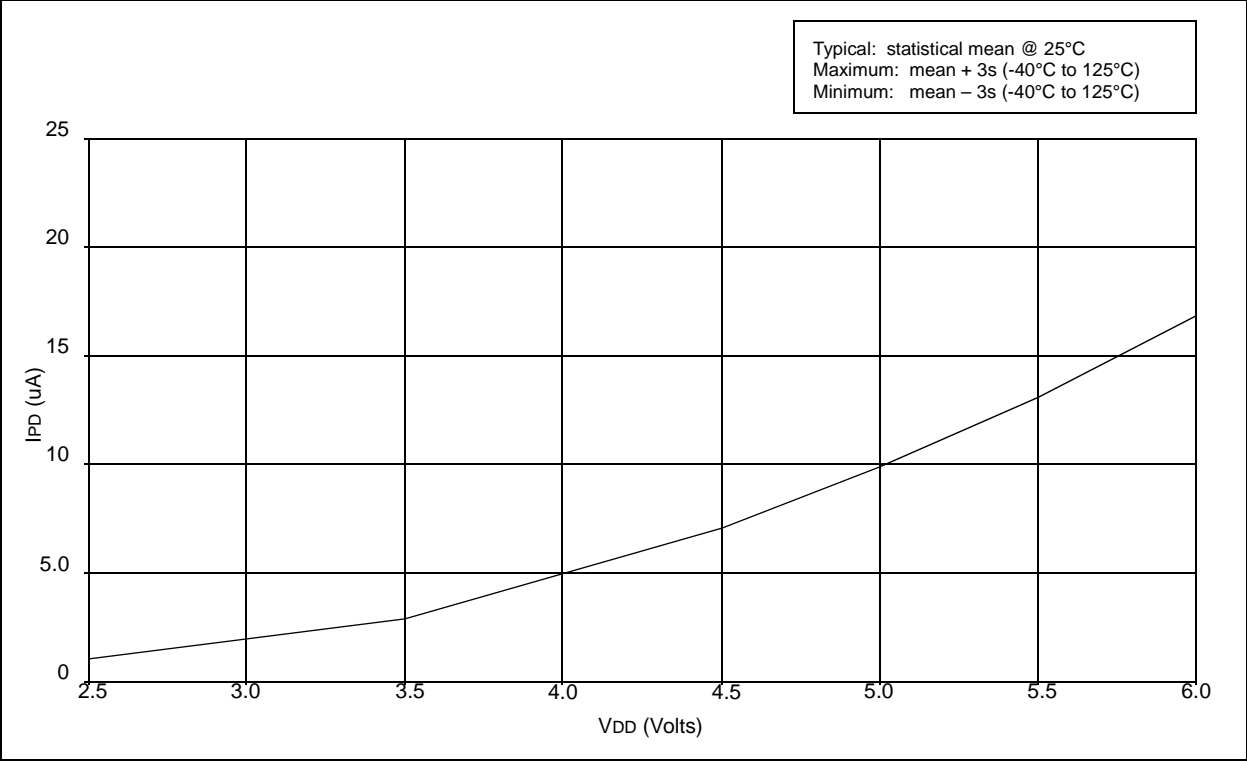
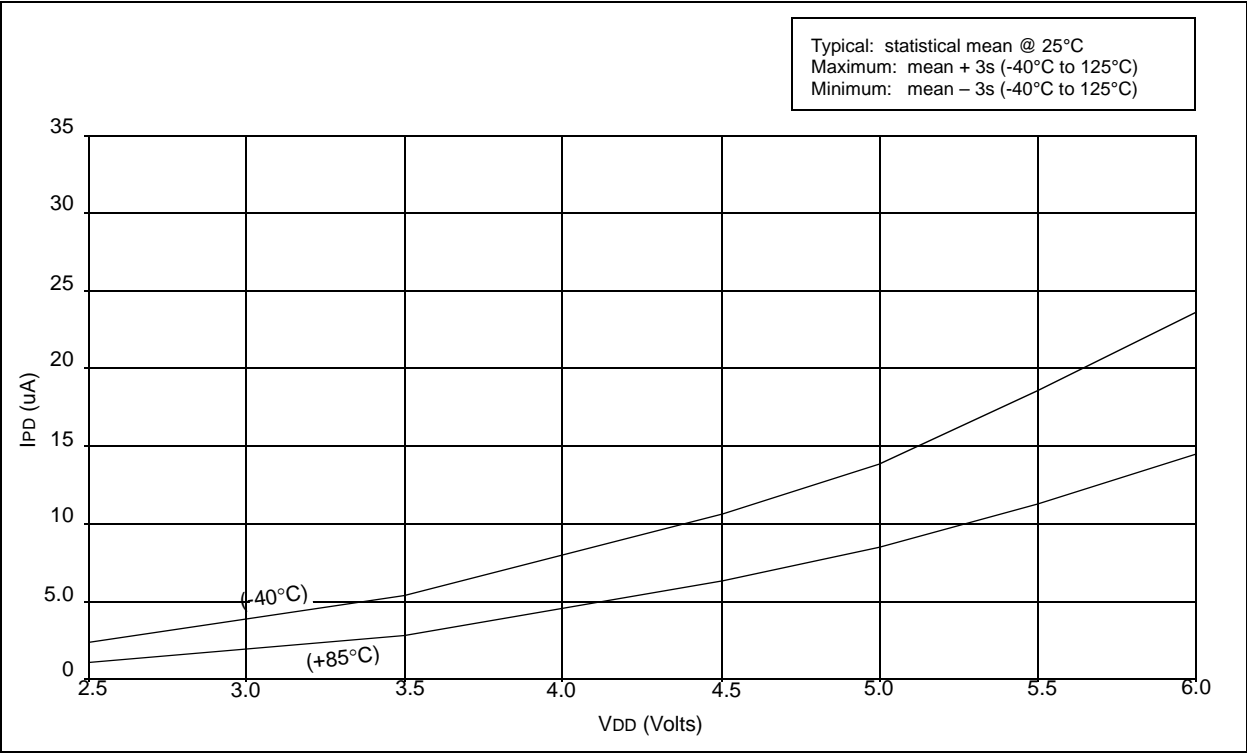
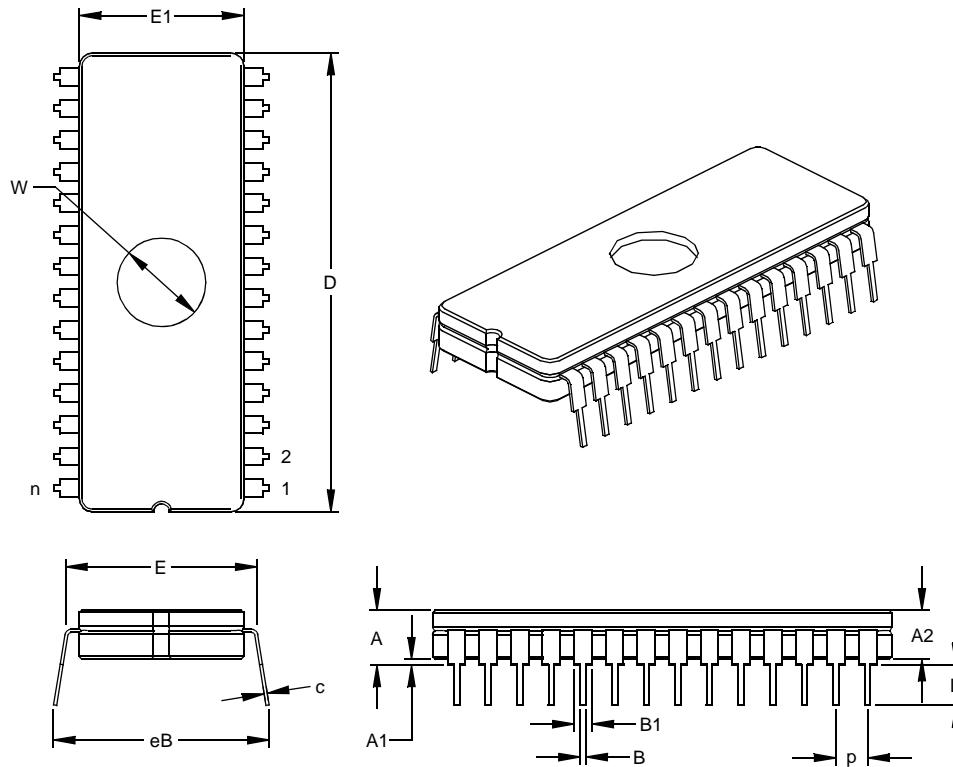


FIGURE 20-3: TYPICAL IPD vs. VDD, WATCHDOG ENABLED (-40°C, 85°C)



## 28-Lead Ceramic Dual In-line with Window (JW) – 600 mil (CERDIP)

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



| Units                      |    | INCHES* |       |       | MILLIMETERS |       |       |
|----------------------------|----|---------|-------|-------|-------------|-------|-------|
| Dimension Limits           |    | MIN     | NOM   | MAX   | MIN         | NOM   | MAX   |
| Number of Pins             | n  |         | 28    |       |             | 28    |       |
| Pitch                      | p  |         | .100  |       |             | 2.54  |       |
| Top to Seating Plane       | A  | .195    | .210  | .225  | 4.95        | 5.33  | 5.72  |
| Ceramic Package Height     | A2 | .155    | .160  | .165  | 3.94        | 4.06  | 4.19  |
| Standoff                   | A1 | .015    | .038  | .060  | 0.38        | 0.95  | 1.52  |
| Shoulder to Shoulder Width | E  | .595    | .600  | .625  | 15.11       | 15.24 | 15.88 |
| Ceramic Pkg. Width         | E1 | .514    | .520  | .526  | 13.06       | 13.21 | 13.36 |
| Overall Length             | D  | 1.430   | 1.460 | 1.490 | 36.32       | 37.08 | 37.85 |
| Tip to Seating Plane       | L  | .125    | .138  | .150  | 3.18        | 3.49  | 3.81  |
| Lead Thickness             | c  | .008    | .010  | .012  | 0.20        | 0.25  | 0.30  |
| Upper Lead Width           | B1 | .050    | .058  | .065  | 1.27        | 1.46  | 1.65  |
| Lower Lead Width           | B  | .016    | .020  | .023  | 0.41        | 0.51  | 0.58  |
| Overall Row Spacing        | §  | eB      | .610  | .660  | 15.49       | 16.76 | 18.03 |
| Window Diameter            | W  | .270    | .280  | .290  | 6.86        | 7.11  | 7.37  |

\* Controlling Parameter  
 § Significant Characteristic  
 JEDEC Equivalent: MO-103  
 Drawing No. C04-013



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